503164741 02/04/2015

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3211356

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
NAOMI ISHII	01/21/2015
KUMIKO KAMIHARA	01/21/2015

RECEIVING PARTY DATA

Name:	HITACHI HIGH-TECHNOLOGIES CORPORATION
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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14417841

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NAME OF SUBMITTER:	JOHN R. MATTINGLY	
SIGNATURE:	/John R. Mattingly/	
DATE SIGNED:	02/04/2015	

Total Attachments: 1

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PATENT 503164741 REEL: 034884 FRAME: 0447

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI HIGH-TECHNOLOGIES CORPORATION, a corporation organized under the laws of Japan,

located at 24-14, Nishi Shimbashi 1-chome, Minato-ku, Tokyo 105-8717 Japan receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI HIGH-TECHNOLOGIES CORPORATION.

its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

DATA PROCESSING DEVICE AND AUTOMATIC ANALYSIS DEVICE USING SAME

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said HITACHI HIGH-TECHNOLOGIES CORPORATION,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference preceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI HIGH-TECHNOLOGIES CORPORATION.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名 日)
1) Naomi Ishii	1/21/2015
Naomi ISHII 2) Kumito Kamihara	1/21/2015
Numiko Naiviinarka	
3)	
4)	
5)	
6)	
7)	
8)	
9)	
10)	

PATENT REEL: 034884 FRAME: 0448

RECORDED: 02/04/2015